

### **LCD Segment Driver series**

# For 128~140 Segment type LCD **LCD Segment Driver**





## BU9728AKV, BU9795AKV/FV/GUW

#### Outline

This is LCD segment driver for 126 to 140 segment type display. There is a lineup which is suitable for multi function display and is integrated display RAM and power supply circuit for LCD driving with 4 common output type: BU9728AKV and BU9795AKV/FV/GUW.

0	128Segment (SEG32×COM4) Driver	BU9728AKV	•••••P.1
0	140Segment (SEG35×COM4) Driver	BU9795AKV/FV/GUW	•••••P.10

#### BU9728AKV 128Segment (SEG32×COM4) Driver

- Feature (BU9728AKV)
  - 1) 4wire serial interface (SCK, SD,  $\overline{C/D}$ ,  $\overline{CS}$ )
  - 2) Integrated RAM for display data (DDRAM): 32 × 4bit (Max 128 Segment)
  - 3) LCD driving port: 4 Common output, 32 Segment output
  - 4) Display duty: 1/4 duty
  - 5) Integrated Oscillator circuit (external resister type)
  - 6) Integrated Power supply circuit for LCD driving (1/3 bias)
  - 7) Low voltage / low power consumption design: +2.5~5.5V
- Uses (BU9728AKV)

DVC, Car audio, Telephone

#### Absolute Maximum Ratings (Ta=25degree, VSS=0V) (BU9728AKV)

	,	<del>0</del> , , , ,	,			
Parameter	Symbol	Limits	Unit	Remarks		
Power Supply Voltage1	VDD	-0.3 ~ +7.0	V	Power supply		
Power Supply Voltage2	VLCD	-0.3 ~ +7.0	V	LCD drive voltage		
Allowable loss	Pd	400	mW	When use more than Ta=25°C, subtract 4mW per degree.		
Operational temperature range	Topr	-40 <b>~</b> +85	degree			
Storage temperature range	Tstg	-55 <b>~</b> +125	degree			
Input voltage range	VIN	-0.3 to VDD+0.3	V			
Output voltage range	VOUT	-0.3 to VDD+0.3	V			

<sup>\*</sup>This product is not designed against radioactive ray.

#### Recommend operating conditions (Ta=25degree, VSS=0V) (BU9728AKV)

Parameter	Symbol	MIN	TYP	MAX	Unit	Remarks
Power Supply Voltage1	VDD	2.5	-	5.5	V	
Power Supply Voltage2	VLCD	0	-	VDD	V	VDD≧V1≧V2≧V3≧VSS
Oscillator frequency	fOSC	-	36	-	KHz	Rf=470kΩ

\*This document is not delivery specifications.

Jul. 2008

• Electrical Characteristics (BU9728AKV)

DC Characteristics (VDD=2.5~5.5V, VSS=0V, Ta=25degree, unless otherwise specified)

5 ,	Symbo		Limit		Uni	O a sa aliti a sa	
Parameter	Ĭ	Min.	Тур.	Max.	t	Condition	Terminal
"H" level input voltage	VIH1	0.8×VDD	-	VDD	V	VO=0.9×VDD or 0.1×VDD	SC1, SD, SCK,
"L" level input voltage	VIL1	0	-	0.2×VDD	٧	VO=0.1×VDD or 0.9×VDD	C/D, CS, RESET
LCD Driver on resistance	RON	-	-	30	kΩ	ΔVON =0.1V	SEG0~31, COM0~3
"L" level Input current1	IIL1	-	-	100	μΑ	VIN=0	RESET
"L" level Input current2	IIL2	-	-	2	μA	VIN=0	OSC1, SD, SCK,
"H" level Input current	IIH	-2	-	-	μA	VIN=VDD	OSC1, SD, SCK, C/D, CS, RESET
Input capacitance	CI	-	5	-	pF		SD, SCK, $\overline{C/D}$ , $\overline{CS}$
		-	0.05	1	μΑ	*2 Display OFF	
Power consumption	IDD	-	40	80	μΑ	*3 Display ON	VDD
		-	100	250	μΑ	*4 MPU Access	

<sup>\*1:</sup> LCD Driver on resistance is not included internal power supply impedance

AC Characteristics (VDD=2.5~5.5V, VSS=0V, Ta=25degree, unless otherwise specified)

Parameter	Symbo		Limit		Unit	Condition
Parameter	I	Min.	Тур.	Max.	Ullit	Condition
SCK rise time	tTLH	-	-	100	ns	
SCK fall time	tTHL	-	-	100	ns	
SCK cycle time	tCYC	800	-	-	ns	
Wait time for command	tWAIT	800	-	-	ns	
SCK pulse width "H"	tWH1	300	-	-	ns	
SCK pulse width "L"	tWL1	300	-	-	ns	
SD setup time	tSU1	100	-	-	ns	
SD hold time	tH1	100	-	-	ns	
CS pulse width "H"	tWH2	300	-	-	ns	
CS pulse width "L"	tWL2	6400	-	-	ns	
CS setup time	tSU2	100	-	-	ns	
CS hold time	tH2	100	-	-	ns	
C/D setup time	tSU3	100	-	-	ns	
C/D hold time	tH3	100	-	-	ns	Based on SCK 8 <sup>th</sup> clock rising
C/D – CS time *5	tCCH	100	-	-	ns	Based on CS rising
C/D – SCK time *5	tSCH	100	-	-	ns	Based o SCK 8 <sup>th</sup> clock falling

<sup>\*5:</sup> Should satisfy either one condition

<sup>\*2:</sup> V3=0V, All input terminal are connected to VDD or VSS.

<sup>\*3:</sup> V3=0V, Rf=470k $\Omega$ , except of OSC1 terminals are connected to VDD or VSS.

<sup>\*4:</sup> V3=0V, Rf=470k $\Omega$ , fSCK=200kHz

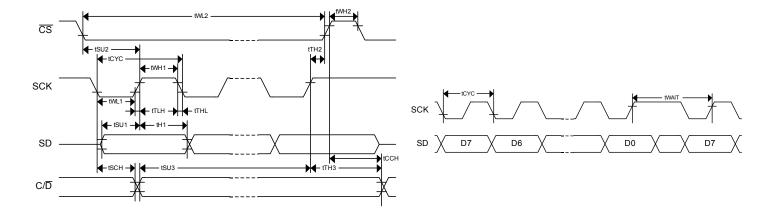


Fig. BU9728AKV-1 Interface timing

Fig. BU9728AKV-2 Command cycle

### Reference data (BU9728AKV)

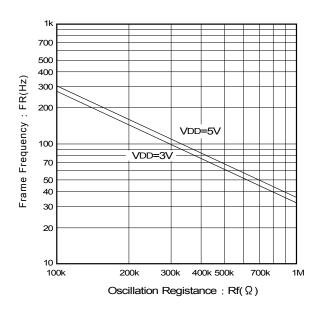


Fig. BU9728AKV-3 Frame frequency vs. Resister value

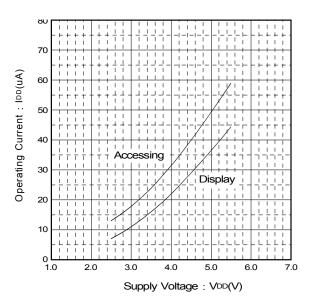
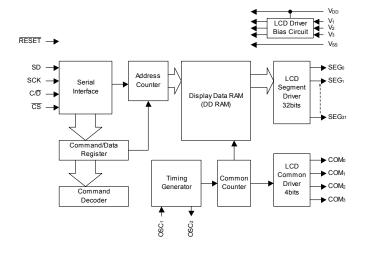


Fig. BU9728AKV-4 Power consumption vs. Power supply

### Block Diagram (BU9728AKV)

### ●Pin Arrangement (BU9728AKV)



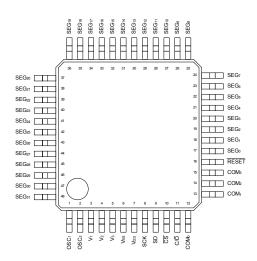


Fig. BU9728AKV-5 Block diagram arrangement

Fig. BU9728AKV-6 Pin

### Terminal description (BU9728AKV)

Terminal	No.	Туре	Function				
OSC1	1	I	Int clock use mode, connect resister between OSC1 and OSC2.				
OSC2	2	0	Ext clock use mode, input clock from OSC1, OSC2 keep OPEN.				
V1~V3	3 <b>~</b> 5		Power supply for LCD driving. Keep VDD≧V1≧V2≧V3≧VSS condition.				
VSS	6		VSS terminal				
VDD	7		VDD terminal				
SCK	8	I	Serial clock input				
SD	9	I	Serial data input				
CS	10	I	Chip select input "L": active				
C/D	11	I	Command data judgment input "L": display data, "H": command				
COM0~3	12~15	0	LCD COMMON output				
RESET	16	I	Reset input terminal. It will be initialized with "L" level input. Reset address counter, Set display off status.				
SEG0~	17~48	0	LCD SEGMENT output				

#### Block Description (BU9728AKV)

#### ADDRESS COUNTER

An address counter shows the address of DDRAM. Address data are transferred to the address counter automatically when an address set is written in the command/data register.

After data are written in DDRAM, +1 or +2 is done automatically with an address counter. The choice of +1 or +2 is done automatically by the next condition.

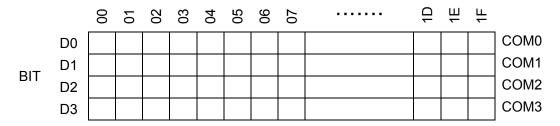
DDRAM 8bit writing (in the 8 clock of SCK,  $C/\overline{D}$ = "L")  $\rightarrow$  +2 DDRAM 4bit rewriting (in the 8 clock of SCK,  $C/\overline{D}$ = "H")  $\rightarrow$  +1

And, when it is counted to 1FH, an address becomes 00H with an address counter by the next count up.

#### O DISPLAY DATA RAM (DDRAM)

A display data RAM (DDRAM) is used to store display data. That capacity is 32 address × 4 bits. DDRAM and the relations of the display position are as the following.

#### DDRAM address



#### ○ TIMING GENERATER

It will be started to oscillate by connecting Rf between OSC1, OSC2, and generated display timing signal. Also it will be able to do by external clock input.



Fig. BU9728AKV-7 Rf Oscillator Circuit

Fig. BU9728AKV-8 External Clock Input

#### COUNTY CONTROLL LCD DRIVE POWER SUPPLY

LCD drive power supply occurs by BU9728AKV. LCD voltage is given by VDD- V3, and it causes V1=2•VLCD/3, V2=VLCD/3. When input LCD power supply by using external breeder register etc.

Please keep below condition.

#### VDD≧V1≧V2≧V3≧VSS

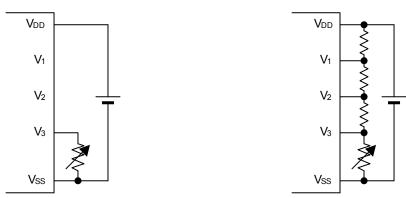


Fig. BU9728AKV-9 Internal Power supply use

Fig. BU9728AKV-10 External Power supply use

<ul> <li>DETAIL OF</li> <li>There is the following</li> </ul>			•		,	ıe 8×n	clock	of SCI	K is C/D= "H".) of BU9728AKV.
O ADDRES	SS SET	Γ							
	MSB								LSB
	0	0	0	Α	Α	Α	Α	Α	
					-	-	-		et on the address counter. t) completes input.
O DISPLA	Y ON								
	MSB			1	1	T.		T	LSB
	0	0	1	*	*	*	*	*	
									*:Don't Care ta RAM (DDRAM). DDRAM don't change.
O DISPLA									
	MSB	T .		T .				T .	LSB
	0	1	0	*	*	*	*	*	
There a							-	-	*:Don't Care ta RAM (DDRAM).
O DISPLA	Y STAF	RT							
	MSE	3		ı	ı	T.			LSB
	0	1	1	*	*	*	*	*	
						-			*:Don't Care with the contents of DDRAM.
○ REWRIT		FTHE	DISP	LAY D	ATA F	RAM (E	DRA	M)	1.00
	MSB		0	*	Ь	Ь		Ь	LSB ]
	1	0	0		D	D	D	D	

\*:Don't Care

The binary four bits data DDDD are written in DDRAM.

A writing address is address ordered by the address set command.

Then, after this command is carried out, an address does + 1 automatically.

○ RESET



\*:Don't Care

Please execute this command first after Power on. It will be initialized as follow conditions;

- · Display OFF
- · Address counter reset

### Recommendation circuit example (BU9728AKV)

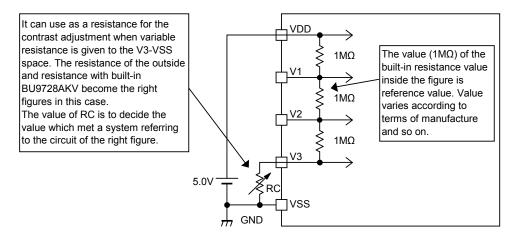


Fig. BU9728AKV-11 When a contrast adjustment mechanism is used.

### ● INPUT OUTPUT CIRCUIT (BU9728AKV)

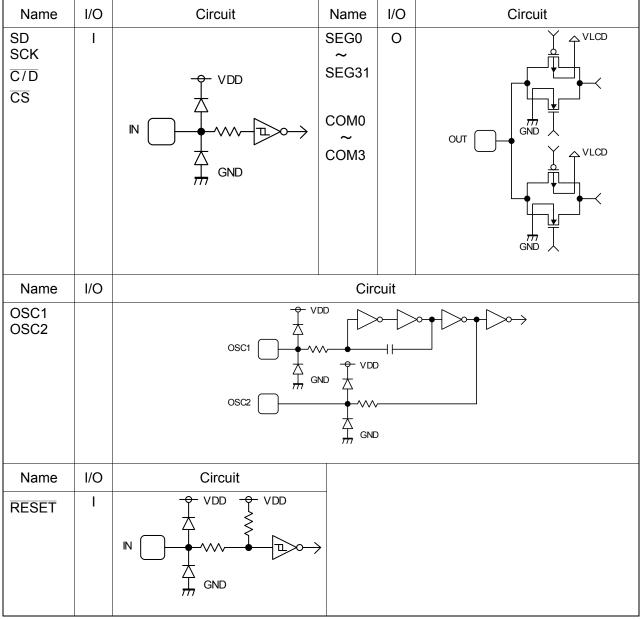


Fig. BU9728AKV-14 INPUT OUTPUT circuit

#### Cautions on use

#### (1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

#### (2) Operating conditions

These conditions represent a range within which characteristics can be provided approximately as expected. The electrical characteristics are guaranteed under the conditions of each parameter.

#### (3) Reverse connection of power supply connector

The reverse connection of power supply connector can break down ICs. Take protective measures against the breakdown due to the reverse connection, such as mounting an external diode between the power supply and the IC's power supply terminal.

#### (4) Power supply line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines. In this regard, or the digital block power supply and the analog block power supply, even though these power supplies has the same level of potential, separate the power supply pattern for the digital block from that for the analog block, thus suppressing the diffraction of digital noises to the analog block power supply resulting from impedance common to the wiring patterns. For the GND line, give consideration to design the patterns in a similar manner. Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use an electrolytic capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

#### GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

#### (6) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

#### (7) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

#### (8) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

#### (9) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

#### (10) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

#### (11) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

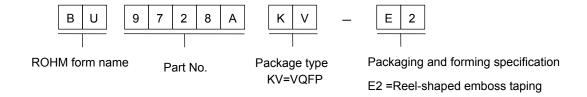
#### (12) No Connecting input terminals

In terms of extremely high impedance of CMOS gate, to open the input terminals causes unstable state. And unstable state brings the inside gate voltage of p-channel or n-channel transistor into active. As a result, battery current may increase. And unstable state can also causes unexpected operation of IC. So unless otherwise specified, input terminals not being used should be connected to the power supply or GND line.

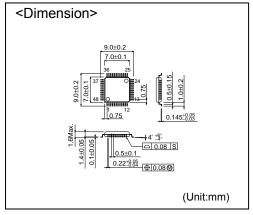
#### (13) Rush current

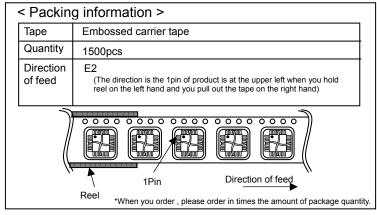
When power is first supplied to the CMOS IC, it is possible that the internal logic may be unstable and rush current may flow instantaneously. Therefore, give special condition to power coupling capacitance, power wiring, width of GND wiring, and routing of connections.

### Order form name selection



### **VQFP48C**





### **BU9795AKV/FV/GUW**

MAX140Segment (SEG35×COM4) Driver

- Feature (BU9795AKV/AFV/AGUW)
  - 1) 3wire serial interface (CSB, SD, SCL)
  - 2) Integrated RAM for display data (DDRAM): 35 × 4bit (Max 140 Segment)
  - 3) LCD driving port: 4 Common output, Segment: 35output (BU9795AKV), 31output (BU9795AGUW), 27output (BU9795AFV)
  - 4) Display duty: 1/4 duty
  - 5) Integrated Buffer AMP for LCD driving power supply
  - 6) 1/2bias, 1/3bias selectable
  - 7) No external components
  - 8) Low power/ Ultra low power consumption design: +2.5~5.5V

#### • Uses (BU9795AKV/AFV/AGUW)

Telephone, FAX, Portable equipment (POS, ECR, PDA etc.), DSC, DVC, Car audio, Home electrical appliance, Meter equipment etc.

• Line-up

- I-			
Parameter	BU9795AKV	BU9795AFV	BU9795AGUW
Segment output	35	27	31
Common output	4	4	4
Package	VQFP48C	SSOP-B40	VBGA48W040

Absolute Maximum Ratings (Ta=25degree, VSS=0V) (BU9795AKV/AFV/AGUW)

• / tb30idtc ividxiiiidiii ita	iiigs (ia	-200cgrcc, voo-0v)	(Beerson avivation)				
Parameter	Symbol Limits		Unit	Remark			
Power supply voltage1	VDD	-0.5 <b>~</b> +7.0	V	Power supply			
Power supply voltage2	VLCD	-0.5 ~ VDD	V	LCD drive voltage			
		0.6	W	When use more than Ta=25°C, subtract 6mW per degree.(BU9795AKV)			
Allowable loss	Pd	0.7	W	When use more than Ta=25°C, subtract 7mW per degree (BU9795AFV)			
		0.27	W	When use more than Ta=25°C, subtract 2.7mW per degree (BU9795AGUW)			
Input voltage range	VIN	-0.5 <b>~</b> VDD+0.5	V				
Operational temperature range	Topr	-40 ~ +85	degree				
Storage temperature range	Tstg	-55 <b>~</b> +125	degree				

<sup>\*</sup>This product is not designed against radioactive ray.

• Recommend operating conditions (Ta=25degree, VSS=0V) (BU9795AKV/AFV/AGUW)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark
Power Supply voltage1	VDD	2.5	-	5.5	V	Power supply
Power Supply voltage2	VLCD	0	-	VDD-2.4	V	LCD drive voltage

<sup>\*</sup> Please use VDD-VLCD ≥ 2.4V condition.

### • Electrical Characteristics(BU9795AKV/AFV/AGUW)

DC Characteristics (VDD=2.5~5.5V, VSS=0V, Ta=-40~85degree, unless otherwise specified)

<b>D</b> 1		Symb		Limit			0 10
Parameter		ol	MIN	TYP	MAX	Unit	Condition
"H" level input voltage	je	VIH	0.7VDD	-	VDD	V	
"L" level input voltag	е	VIL	VSS	-	0.3VDD	V	
"H" level input currer	nt	IIH	-	-	1	uA	
"L" level input currer	nt	IIL	-1	-	-	uA	
LCD Driver on	SEG	RON	-	3.5	-	kΩ	Iload=±10uA
resistance	COM	RON	-	3.5	-	kΩ	
VLCD supply voltage	е	VLCD	0	-	VDD -2.4	V	VDD-VLCD≧2.5V
Standby current		Ist	-	-	5	uA	Display off, Oscillator off
Power consumption 1		IDD1	-	12.5	30	uA	VDD=3.3[V], Ta=25, Power save mode1, FR=70Hz 1/3 bias, Frame inverse
Power consumption	2	IDD2	-	20	40	uA	VDD=3.3[V], Ta=25, Normal mode, FR=80Hz 1/3 bias, Line inverse

### • Oscillation Characteristics (BU9795AKV/AFV/AGUW)

(VDD=2.5~5.5V,VSS=0V, Ta=-40~85degree)

Parameter	Symb		Limit		Unit	Condition
Parameter	ol	MIN	TYP	MAX	Offic	Condition
Frame frequency	<b>f</b> clk	56	80	104	Hz	FR = 80Hz setting
Frame frequency1	f <sub>CLK1</sub>	70	80	90	Hz	VDD=3.5V, 25degree

### • MPU interface Characteristics (BU9795AKV/AFV/AGUW)

(VDD=2.5V~5.5V,VSS=0V, Ta=-40~85degree)

Parameter	Symb		Limit		Unit	Condition	
Parameter	ol	MIN	TYP	MAX	Offic	Condition	
Input rise time	tr	-	-	80	ns		
Input fall time	tf	-	-	80	ns		
SCL cycle time	tSCY	400	-	-	ns		
"H" SCL pulse width	tSHW	100	-	-	ns		
"L" SCL pulse width	tSLW	100	-	-	ns		
SD setup time	tSDS	20	-	-	ns		
SD hold time	tSDH	50	-	-	ns		
CSB setup time	tCSS	50	-	-	ns		
CSB hold time	tCSH	50	-	-	ns		
"H" CSB pulse width	tCHW	50	-	-	ns		

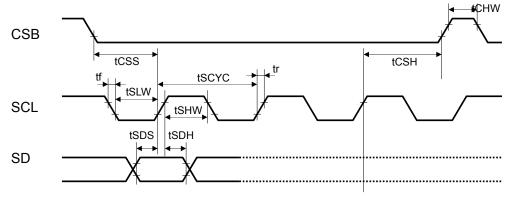


Fig.BU9795AKV/FV/GUW-1 3wire Serial timing waveform

### \* BU9795AKV

### • Block Diagram

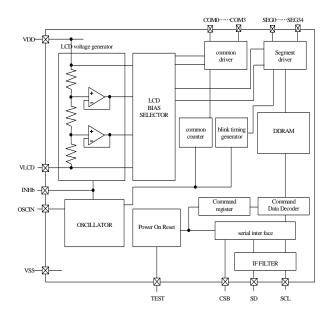


Fig. BU9795AKV /AFV /AGUW-2A BU9795AKV Block diagram

### • Pin Arrangement

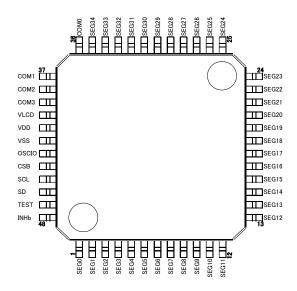


Fig. BU9795AKV /AFV /AGUW-3A BU9795AKV Pin arrangement

### • Terminal description

Terminal	Terminal No.	I/O	Function
INHb	48	I	Input terminal for turn off display H: turn on display L: turn off display
TEST	47	I	Test input (ROHM use only) Must be connect to VSS
OSCIO	43	1	External clock input Ex clock and Int clock can be changed by command. Must be connect to VSS when use internal oscillation circuit.
SD	46	I	serial data input
SCL	45	I	serial data transfer clock
CSB	44	I	Chip select : "L" active
VSS	42		GND
VDD	41		Power supply
VLCD	40		Power supply for LCD driving
SEG0-34	1-35	0	SEGMENT output for LCD driving
COM0-3	36-39	0	COMMON output for LCD driving

### \* BU9795AFV

### • Block Diagram

# 

### Pin Arrangement

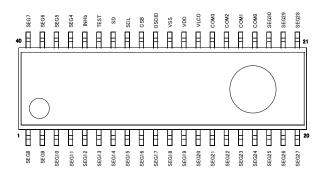


Fig. BU9795AKV /AFV /AGUW-2B BU9795AFV Block diagram

Fig. BU9795AKV /AFV /AGUW-3B BU9795AFV Pin arrangement

### • Terminal description

Terminal	Terminal No.	I/O	Function
INHb	36	I	Input terminal for turn off display H: turn on display L: turn off display
TEST	35	I	Test input (ROHM use only) Must be connect to VSS
OSCIO	31	I	External clock input Ex clock and Int clock can be changed by command. Must be connect to VSS when use internal oscillation circuit.
SD	34	I	serial data input
SCL	33	I	serial data transfer clock
CSB	32	I	Chip select : "L" active
VSS	30		GND
VDD	29		Power supply
VLCD	28	I	Power supply for LCD driving
SEG4-30	1-23, 37-40	0	SEGMENT output for LCD driving
COM0-3	24-27	0	COMMON output for LCD driving

### \* BU9795AGUW

### • Block Diagram

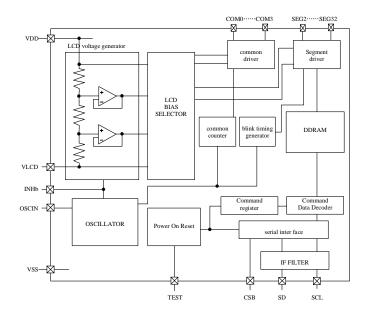


Fig. BU9795AKV /AFV /AGUW-2C BU9795AGUW Block diagram

### Pin Arrangement

	1	2	3	4	5	6	7
G	(NC)	SEG13	SEG15	SEG18	SEG20	SEG22	(NC)
F	SEG11	SEG12	SEG16	SEG17	SEG21	SEG23	SEG24
Е	SEG9	SEG10	SEG14	SEG19	SEG25	SEG27	SEG26
D	SEG7	SEG6	SEG8	SEG5	SEG30	SEG28	SEG29
С	SEG4	SEG3	SEG2	CSB	сомз	SEG32	SEG31
В	$\times$	INHb	SD	vss	VDD	сом1	сомо
Α	(NC)	TEST2	SCL	oscio	VLCD	COM2	(NC)

Fig. BU9795AKV /AFV /AGUW-3C BU9795AGUW Pin arrangement

### • Terminal description

Terminal	I/O	Function			
INHb	I	Input terminal for turn off display H: turn on display L: turn off display			
TEST	-	Test input (ROHM use only) Must be connect to VSS			
OSCIO	I	External clock input Ex clock and Int clock can be changed by command. Must be connect to VSS when use internal oscillation circuit.			
SD	I	serial data input			
SCL	I	serial data transfer clock			
CSB	I	Chip select : "L" active			
VSS		GND			
VDD		Power supply			
VLCD	I	Power supply for LCD driving			
SEG2-32	0	SEGMENT output for LCD driving			
COM0-3	0	COMMON output for LCD driving			

(Caution) About terminal number, please refer to above pin arrangement

### • Command Description (BU9795AKV/AFV/AGUW)

D7 (MSB) is bit for command or data judgment. Refer to Command and data transfer method.

C: 0: Next byte is RAM write data.

1: Next byte is command.

### ○ Mode Set (MODE SET)

MSB							LSB	
D7								
С	1	0	*	P3	P2	*	*	(*:Don't care)

### Set display ON and OFF

Setting	P3	Reset initialize condition
Display OFF (DISPOFF)	0	0
Display ON (DISPON)	1	

### Set bias level

Setting	P2	Reset initialize condition
1/3 Bias	0	0
1/2 Bias	1	

### Address set (ADSET)

MSB							LSB
					D2		
С	0	0	P4	P3	P2	P1	P0

Address data is specified in P[4:0] and P2 (ICSET command) as follows.

MSB LSB

Internal register	Address [5]	Address [4]	 Address [0]
Bit of each command	ICSET [P2]	ADSET [P4]	 ADSET [P0]

### Display control (DISCTL)

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0
С	0	1	P4	P3	P2	P1	P0

### Set Frame frequency

Setting	P4	P3	Reset initialize condition
80Hz	0	0	0
71Hz	0	1	
64Hz	1	0	
53Hz	1	1	

### Set LCD drive waveform

Setting	P2	Reset initialize condition
Line inversion	0	0
Frame inversion	1	

### Set Power save mode

Setting	P1	P0	Reset initialize condition
Power save mode 1	0	0	
Power save mode 2	0	1	
Normal mode	1	0	0
High power mode	1	1	

<sup>\*</sup> VDD-VLCD>=3.0V is required for High power mode.

### ∘ Set IC Operation (ICSET)

MSB	3										
D7	D6	D5	D4	D3	D2	D1	D0				
С	1	1	0	1	P2	P1	P0				

### P2: MSB data of DDRAM address. Please refer to "ADSET" command.

Setting	P2	Reset initialize condition
Address MSB'0'	0	0
Address MSB'1'	1	

### Set Software Reset condition

Setting	P1
No operation	0
Software Reset	1

### Switch between internal clock and external clock.

Setting	P0	Reset initialize condition
Internal clock	0	0
External clock input	1	

### o Blink control (BLKCTL)

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0
С	1	1	1	0	*	P1	P0

### Set blink condition

Setting	P1	P0	Reset initialize condition
OFF	0	0	0
0.5 Hz	0	1	
1 Hz	1	0	
2 Hz	1	1	

### o All pixel control (APCTL)

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0
С	1	1	1	1	1	P1	P0

### All display set ON. OFF

Setting	P1	Reset initialize condition
Normal	0	0
All pixel ON	1	

Setting	P0	Reset initialize condition
Normal	0	0
All pixel OFF	1	

- Function description (BU9795AKV/AFV/AGUW)
  - o Command and data transfer method
  - 3-SPI (3wire Serial interface)

This device is controlled by 3-wire signal (CSB, SCL, and SD).

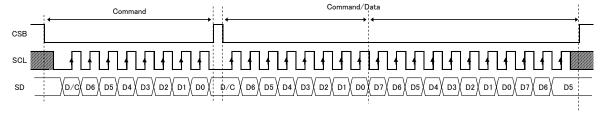
First, Interface counter is initialized with CSB="H",

and CSB="L" makes SD and SCL input enable.

The protocol of 3-SPI transfer is as follows.

Each command starts with Command or Data judgment bit (D/C) as MSB data, and continuously in order of D6 to D0 are followed after CSB ="L".

(Internal data is latched at the rising edge of SCL, it converted to 8bits parallel data at the falling edge of 8<sup>th</sup> CLK.)



D/C = "H" : Command D/C = "L" : Data

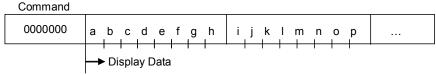
Fig. BU9795AKV /AFV /AGUW-10 3-SPI Command/Data transfer format

Write display data and transfer method

\* BU9795AKV

This LSI have Display Data RAM (DDRAM) of 35×4=140bit.

The relationship between data input and display data, DDRAM data and address are as follows.



8 bit data will be stored in DDRAM. The address to be written is the address specified by Address set command, and the address is automatically incremented in every 4bit data.

Data can be continuously written in DDRAM by transmitting Data continuously. (When RAM data is written successively after writing RAM data to 22h (SEG34), the address is returned to 00h (SEG0) by the auto-increment function.

#### DDRAM address 00h 01h 02h 03h 04h 05h 06h 07h 1Eh 1Fh 20h 21h 22h 0 COM<sub>0</sub> i а e m q u f COM<sub>1</sub> 1 b j n r ٧ **BIT** 2 k COM<sub>2</sub> С 0 s Х g COM3 3 d h Ι t р У SEG5 SEG1 SEG2 SEG3 SEG4 SEG6 SEG7 SEG30 SEG31 SEG32 SEG33

As data transfer to DDRAM happens every 4bit data, it will be cancelled if it changes CSB="L"→"H" before 4bits data transfer.

### \* BU9795AFV

As SEG0, SEG1, SEG2, SEG3, SEG31, SEG32, SEG33, SEG34 are not output, these address will be dummy address.

	Dummy data					DDRAM address				Dummy data				L		
		00h	01h	02h	03h	04h	05h	06h	07h			1Fh	20h	21h	22h	
	0	а	е	i	m	q	u									СОМ0
	1	b	f	j	n	r	٧									COM1
BIT	2	С	g	k	0	S	Х									COM2
	3	d	h	I	р	t	у									СОМЗ
		SEG0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7		SEG30	SEG31	SEG32	SEG33	SEG34	4

As data transfer to DDRAM happens every 4bit data, it will be cancelled if it changes CSB="L"→"H" before 4bits data transfer.

#### \* BU9795AGUW

As SEG0, SEG1, SEG33, SEG34 are not output, these address will be dummy address.

		Dummy data					DDRAM address						Dummy data			
		00h	01h	02h	03h	04h	05h	06h	07h		1Eh	1Fh	20h	21h	22h	
BIT	0	а	е	i	m	q	u									СОМО
	1	b	f	j	n	r	٧									COM1
	2	С	g	k	0	S	х									COM2
	3	d	h	ı	р	t	у									СОМ3
		SEG0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7		SEG30	SEG31	SEG32	SEG33	SEG34	<u> </u>

As data transfer to DDRAM happens every 4bit data, it will be cancelled if it changes CSB="L"—"H" before 4bits data transfer.

### o Reset (initial) condition

Initial condition after execute Software Reset is as follows.

- · Display is OFF.
- DDRAM address is initialized (DDRAM Data is not initialized).
- Refer to Command Description about initialize value of register.

### ● Cautions of Power-On condition (BU9795AKV /AFV /AGUW)

This LSI has "P.O.R" (Power-On Reset) circuit and Software Reset function. Please keep the following recommended Power-On conditions in order to power up properly.

1. Please set power up conditions to meet the recommended tR, tF, tOFF, and Vbot spec below in order to ensure P.O.R operation.

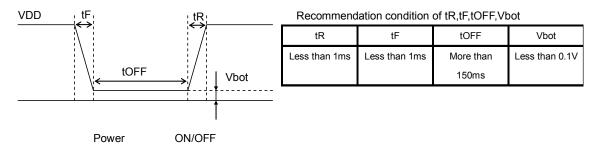
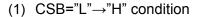


Fig. BU9795AKV /AFV /AGUW-18 Power on-off waveform

2. If it is difficult to meet above conditions, execute the following sequence after Power-On.

Because it doesn't accept the command in power off, it is necessary to care that correspondence by software reset doesn't become alternative to POR function completely.



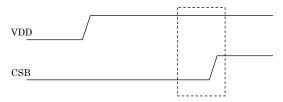


Fig. BU9795AKV-19 CSB Timing

(2) After CSB"H"→"L", execute Software Reset (ICSET command).

### ■ IO Circuit (BU9795AKV /AFV /AGUW)

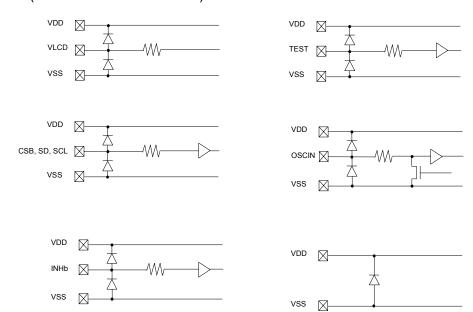


Fig. BU9795AKV /AFV /AGUW-20 IO circuit

#### Cautions on use

#### (1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

#### (2) Operating conditions

These conditions represent a range within which characteristics can be provided approximately as expected. The electrical characteristics are guaranteed under the conditions of each parameter.

#### (3) Reverse connection of power supply connector

The reverse connection of power supply connector can break down ICs. Take protective measures against the breakdown due to the reverse connection, such as mounting an external diode between the power supply and the IC's power supply terminal.

#### (4) Power supply line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines. In this regard, or the digital block power supply and the analog block power supply, even though these power supplies has the same level of potential, separate the power supply pattern for the digital block from that for the analog block, thus suppressing the diffraction of digital noises to the analog block power supply resulting from impedance common to the wiring patterns. For the GND line, give consideration to design the patterns in a similar manner. Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use an electrolytic capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

#### (5) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

#### (6) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

#### 7) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

#### (8) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

#### (9) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

#### (10) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

#### (11) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

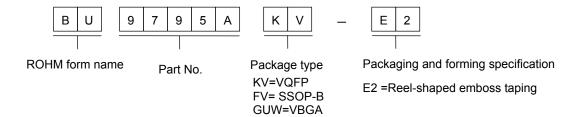
#### (12) No Connecting input terminals

In terms of extremely high impedance of CMOS gate, to open the input terminals causes unstable state. And unstable state brings the inside gate voltage of p-channel or n-channel transistor into active. As a result, battery current may increase. And unstable state can also causes unexpected operation of IC. So unless otherwise specified, input terminals not being used should be connected to the power supply or GND line.

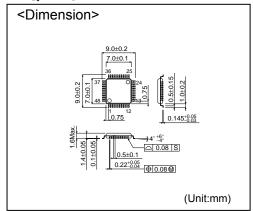
#### (13) Rush current

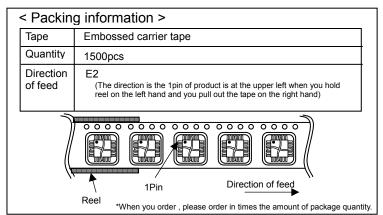
When power is first supplied to the CMOS IC, it is possible that the internal logic may be unstable and rush current may flow instantaneously. Therefore, give special condition to power coupling capacitance, power wiring, width of GND wiring, and routing of connections.

### Order form name selection

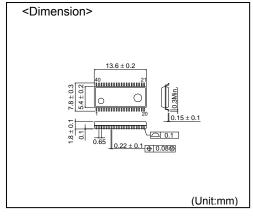


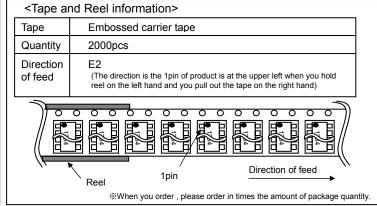
### VQFP48C



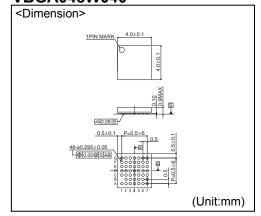


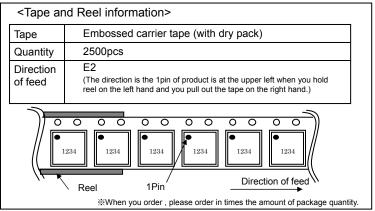
#### SSOP-B40





### VBGA048W040





■ The contents described herein are correct as of July, 2008

● The contents described herein are subject to change without notice. For updates of the latest information, please contact and confirm with ROHM CO.,LTD. 
● Any part of this application note must not be duplicated or copied without our permission.

San Diego Atlanta

Boston Chicago Dallas

Denver

Munich

Stuttgart

Denmark

Barcelona

Hungary Poland

Russia

Masan

Beijing

Espoo

Oulu

Deriver Detroit Nashville Mexico Düsseldorf

- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams and information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by ROHM CO., LTD. is granted to any such buyer.

■ The products described herein utilize silicon as the main material. ● The products described herein are not designed to be X ray proof.

The products listed in this catalog are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

Excellence in Electronics



### ROHM CO., LTD.

21 Saiin Mizosaki-cho, Ukyo-ku, Kyoto 615-8585, Japan TEL: +81-75-311-2121 FAX: +81-75-315-0172 URL http://www.rohm.com

Published by KTC LSI Development Headquarters LSI Business Pomotion Group

### Contact us for further information about the products.

TEL: +1-858-625-3630 TEL: +1-770-754-5972 TEL: +1-978-371-0382 FAX: +1-858-625-3670 FAX: +1-770-754-0691 FAX: +1-928-438-7164 TEL: +1-847-368-1006 FAX: +1-847-368-1008 TEL: +1-469-287-5366 FAX: +1-469-362-7973 FAX: +1-469-362-7973 FAX: +1-303-708-0858 FAX: +1-248-348-9942 FAX: +1-615-620-6702 FAX: +52-33-3123-2002 FAX: +49-2154-921400 TEL: +1-303-708-0908 TEL: +1-303-708-0908 TEL: +1-248-348-9920 TEL: +1-615-620-6700 TEL: +52-33-3123-2001 TEL: +49-2154-9210 TEL: +49-899-216168 FAX: +49-899-216176 TEL: +49-899-216168
TEL: +49-711-72723710
TEL: +33-1-5697-3060
TEL: +44-1-908-306700
TEL: +45-3694-4739
TEL: +358-9725-54491 FAX: +49-711-72723720 FAX: +49-711-72723720 FAX: +33-1-5697-3080 FAX: +441-908-235788 FAX: +45-3694-4789 FAX: +358-9-7255-4499 FAX: +358-2-7332237 France United Kingdom TEL: +358-2-7332234 TEL: +358-8-5372930 FAX: +358-8-5372931 TEL: +358-8-5372930 TEL: +34-9375-24320 TEL: +36-1-4719338 TEL: +48-22-5757213 TEL: +7-95-980-6755 TEL: +82-2-8182-700 FAX: +34-9375-24410 FAX: +36-1-4719339 FAX: +48-22-5757001 FAX: +7-95-937-8290 FAX: +82-2-8182-715 TEL: +82-55-240-6234 FAX: +82-55-240-6236 TEL: +86-411-8230-8549 FAX: +86-411-8230-8537 TEL: +86-10-8525-2483 FAX: +86-10-8525-2489

Shanghai Hangzhou Nanjing Ningbo Qingdao Suzhou Wuxi Shenzhen Dongguan Fuzhou Guangzhou Huizhou Xiamen Zhuhai Hong Kong Taipei Kaohsiung Kuala Lumpu Penang Kvoto Yokohama

Tianjin

TEL: +86-22-23029181 FAX: +86-22-23029183
TEL: +86-21-6279-2727 FAX: +86-21-6247-2066
TEL: +86-571-87658072 FAX: +86-571-87658071
TEL: +86-25-8689-0015 FAX: +86-25-8689-0393 TEL: +86-574-87654201 FAX: +86-574-87654208 TEL: +86-5/4-8/694201 FAX: +86-5/4-8/694208 TEL: +86-5/2-5/79-615 FAX: +86-5/2-5/79-653 TEL: +86-51-2-6807-1300 FAX: +86-51-2-6807-2300 TEL: +86-510-82702992 TEL: +86-755-8307-3008 FAX: +86-755-8307-3003 TEL: +86-769-8399-4140 TEL: +86-591-8801-8698 FAX: +86-591-8801-8690 TEL: +86-591-8801-8698 TEL: +86-20-3878-8100 TEL: +86-752-205-1054 TEL: +86-592-238-5705 TEL: +86-756-3232-480 TEL: +852-2-740-6262 FAX: +86-20-3825-5965 FAX: +86-752-205-1059 FAX: +86-752-239-8380 FAX: +86-756-3232-460 FAX: +852-2-375-8971 TEL: +886-2-2500-6956 FAX: +886-2-2503-2869 TEL: +886-7-237-0881 FAX: +886-7-238-7332 FAX: +886-7-238-7332 FAX: +65-6332-5662 FAX: +63-2-809-1422 FAX: +66-2-256-6334 FAX: +60-3-7958-8377 FAX: +60-4-2286452 FAX: +81-75-365-1228 TEL: +65-6332-2322 TEL: +65-6332-2322 TEL: +63-2-807-6872 TEL: +66-2-254-4890 TEL: +60-3-7958-8355 TEL: +60-4-2286453 TEL: +81-75-365-1218 TEL: +81-45-476-2290 FAX: +81-45-476-2295

#### **Notes**

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM CO.,LTD.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.

Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact your nearest sales office.

**ROHM Customer Support System** 

THE AMERICAS / EUROPE / ASIA / JAPAN

www.rohm.com

Contact us : webmaster@rohm.co.jp

Copyright © 2009 ROHM CO.,LTD.

ROHM Co., Ltd. 21 Saiin Mizosaki-cho, Ukyo-ku, Kyoto 615-8585, Japan

TEL:+81-75-311-2121 FAX:+81-75-315-0172

